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September 2009

# NC7SZ38 TinyLogic<sup>®</sup> UHS 2-Input NAND Gate, Open Drain Output

#### **Features**

- Ultra-High Speed: t<sub>PD</sub> 2.4ns (Typical) into 50pF at 5V V<sub>CC</sub>
- Open Drain Output Stage for OR Tied Applications
- High Output Sink Drive: 24mA at 3V V<sub>CC</sub>
- Broad V<sub>CC</sub> Operating Range: 1.65V to 5.5V
- Matches Performance of LCX Operated at 3.3V V<sub>CC</sub>
- Power Down High-Impedance Inputs/Outputs
- Over-Voltage Tolerance Inputs Facilitate 5V to 3V Translation
- Proprietary Noise/EMI Reduction Circuitry
- Ultra-Small MicroPak™ Packages
- Space-Saving SOT23 and SC70 Packages

#### Description

The NC7SZ38 is a single 2-Input NAND gate with open drain output stage from Fairchild's Ultra-High Speed Series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra-high speed with high output drive while maintaining low static power dissipation over a very broad Vcc operating range. The device is specified to operate over the 1.65V to 5.5V Vcc range. The inputs and output are high impedance when Vcc is 0V. Inputs tolerate voltages up to 6V independent of Vcc operating voltage. The open drain output stage tolerates voltages up to 6V independent of Vcc when in the high impedance state.

## **Ordering Information**

Part Number	Top Mark	Eco Status	Package	Packing Method
NC7SZ38M5X	7Z38	RoHS	5-Lead SOT23, JEDEC MO-178 1.6mm	3000 Units on Tape & Reel
NC7SZ38P5X	Z38	RoHS	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3000 Units on Tape & Reel
NC7SZ38L6X	7SZ38L6X A6 RoHS 6-		6-Lead MicroPak™, 1.00mm Wide	5000 Units on Tape & Reel
NC7SZ38FHX	C7SZ38FHX A6 Green		6-Lead, MicroPak2, 1x1mm Body, .35mm Pitch	5000 Units on Tape & Reel

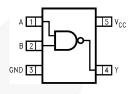
For Fairchild's definition of Eco Status, please visit: <a href="http://www.fairchildsemi.com/company/green/rohs-green.html">http://www.fairchildsemi.com/company/green/rohs-green.html</a>.

## **Connection Diagrams**



Figure 1. Logic Symbol

## **Pin Configurations**



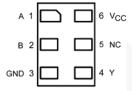


Figure 2. SC70 and SOT23 (Top View)

Figure 3. MicroPak™ (Top Through View)

#### **Pin Definitions**

Pin # SC70 / SOT23	Pin # MicroPak	Name	Description
1	1	A	Input
2	2	В	Input
3	3	GND	Ground
4	4	Y	Output
5	6	V <sub>CC</sub>	Supply Voltage
	5	NC	No Connect

#### **Function Table**

Y=/AB

Inp	uts	Output
Α	В	Υ
L	L	*H
L	Н	*H
Н	L	*H
Н	Н	L

H = HIGH Logic Level

L = LOW Logic Level

\*H = High Impedance Output State, Open Drain

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Para	ameter	Min.	Max.	Unit	
V <sub>CC</sub>	Supply Voltage		-0.5	6.0	V	
$V_{IN}$	DC Input Voltage		-0.5	6.0	V	
V <sub>OUT</sub>	DC Output Voltage		-0.5	6.0	V	
ı	DC Input Diada Current	V <sub>IN</sub> < -0.5V		-50	m A	
I <sub>IK</sub>	DC Input Diode Current	V <sub>IN</sub> > 6.0V		+20	- mA	
	DC Output Diada Cumant	V <sub>OUT</sub> < -0.5V		-50	A	
l <sub>OK</sub>	DC Output Diode Current	V <sub>OUT</sub> > 6V, V <sub>CC</sub> =GND		+20	- mA	
l <sub>out</sub>	DC Output Current			+50	mA	
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current			±50	mA	
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C	
TJ	Junction Temperature Under B	ias		+150	°C	
T <sub>L</sub>	Junction Lead Temperature (S	oldering, 10 Seconds)		+260	°C	
		SOT-23		200		
Ъ	Daway Dissipation at 10500	SC70-5		150	\^/	
$P_D$	Power Dissipation at +85°C	MicroPak-6		130	mW	
		MicroPak2-6		120		
FCD	Human Body Model, JEDEC:JI	ESD22-A114		4000	\/	
ESD	Charge Device Model, JEDEC:	JESD22-C101		2000	V	

## **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit
	Supply Voltage Operating		1.65	5.50	V
V <sub>CC</sub>	Supply Voltage Data Retention		1.50	5.50	7 V
V <sub>IN</sub>	Input Voltage		0	5.5	V
V <sub>OUT</sub>	Output Voltage		0	5.5	V
T <sub>A</sub>	Operating Temperature		-40	+85	°C
		V <sub>CC</sub> =1.8V, 2.5V ± 0.2V	0	20	$\prec$
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Times	V <sub>CC</sub> =3.3V ± 0.3V	0	10	ns/V
		V <sub>CC</sub> =5.0V ± 0.5V	0	5	
		SOT-23		300	
0	Thermal Resistance	SC70-5		425	00/4/
$\theta_{\sf JA}$		MicroPak-6		500	°C/W
		MicroPak2-6		560	

#### Note:

1. Unused inputs must be held HIGH or LOW. They may not float.

## **DC Electrical Characteristics**

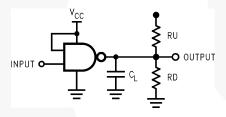
Oh l	D	v	V Canaditiana	T,	T <sub>A</sub> =+25°C			T <sub>A</sub> =-40 to +85°C		
Symbol	Parameter	V <sub>cc</sub>	Conditions	Min.	Тур.	Max.	Min.	Max.	Units	
V <sub>IH</sub>	HIGH Level Input	1.65 to 1.95		0.75V <sub>CC</sub>			0.75V <sub>CC</sub>		V	
VIH	Voltage	2.30 to 5.50		0.70V <sub>CC</sub>			$0.70V_{CC}$		V	
VIL	LOW Level Input	1.65 to 1.95				0.25V <sub>CC</sub>		0.25V <sub>CC</sub>	V	
V IL	Voltage	2.30 to 5.50				0.30V <sub>CC</sub>		0.30V <sub>CC</sub>	V	
$I_{LKG}$	HIGH Level Output Leakage	5.50	$V_{IN}=V_{IL},$ $V_{OUT}=V_{CC}$ or GND			±5		±10	μΑ	
		1.65			0.00	0.10		0.10		
	1.80 2.30 3.00	1.80			0.00	0.10		0.10		
		2.30	V <sub>IN</sub> =V <sub>IH</sub> , I <sub>OL</sub> =100		0.00	0.10		0.10		
		3.00			0.00	0.10		0.10		
$V_{OL}$	LOW Level	4.50			0.00	0.10		0.10	V	
VOL	Output Voltage	1.65			0.80	0.24		0.24	V	
		2.30	I <sub>OL</sub> =8mA		0.10	0.30		0.30		
		3.00	I <sub>OL</sub> =16mA		0.15	0.40		0.40		
		3.00	I <sub>OL</sub> =24mA		0.22	0.55		0.55		
	7	4.50	I <sub>OL</sub> =32mA		0.22	0.55		0.55		
I <sub>IN</sub>	Input Leakage Current	5.50	V <sub>IN</sub> =5.5V, GND			±1		±10	μΑ	
I <sub>OFF</sub>	Power Off Leakage Current	0	V <sub>IN</sub> or V <sub>OUT</sub> =5.5V			1		10	μΑ	
I <sub>CC</sub>	Quiescent Supply Current	5.50	V <sub>IN</sub> =5.5V, GND			2		20	μΑ	

#### **AC Electrical Characteristics**

Symbol	Parameter	V	Conditions	T,	<sub>4</sub> =+25°(	<b>)</b>	T <sub>A</sub> =-40 1	to +85°C	Units	Figure	
Syllibol	Parameter	V <sub>cc</sub>	Conditions	Min.	Тур.	Max.	Min.	Max.	UIIIIS	Figure	
		1.65	1.5	6.5	12.7	1.5	13.2				
		1.80	C <sub>L</sub> =50pF,	1.5	5.4	10.5	1.5	11.0			
t <sub>PZL</sub>		2.50 ± 0.20	RU=500 $\Omega$ , RD-500 $\Omega$ ,	0.8	3.5	7.0	0.8	7.5			
		$3.30 \pm 0.30$	V <sub>IN</sub> =2•V <sub>CC</sub>	0.8	2.8	5.0	0.8	5.2			
	Propagation Delay	$5.00 \pm 0.50$		0.5	2.2	4.3	0.5	4.5	ns	nc ''	Figure 4
		1.65		1.5	5.5	12.7	1.5	13.2			Figure 5
		1.80		1.5	4.6	10.5	1.5	11.0			
$t_{PLZ}$		0.8	3.0	7.0	0.8	7.5					
		$3.30 \pm 0.30$	V <sub>IN</sub> =2•V <sub>CC</sub>	0.8	2.1	6.0	0.8	5.2			
		5.00 ± 0.50		0.5	1.3	4.3	0.5	4.5			
C <sub>IN</sub>	Input Capacitance	0.00			4.0				pF		
C <sub>OUT</sub>	Output Capacitance	0.00		·	5.0				pF		
C <sub>PD</sub>	Power Dissipation	3.30			5.1				pF	Figure 6	
OPD	Capacitance <sup>(2)</sup>	5.00			7.3				Ы	r igule 0	

#### Note:

2.  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption ( $I_{CCD}$ ) at no output loading and operating at 50% duty cycle.  $C_{PD}$  is related to  $I_{CCD}$  dynamic operating current by the expression:  $I_{CCD} = (C_{PD})(V_{CC})(f_{IN}) + (I_{CCS} + I_{CC})$ .



#### Note:

 C<sub>L</sub> includes load and stray capacitance. Input PRR=10MHz t<sub>w</sub>=500ns.

Figure 4. AC Test Circuit

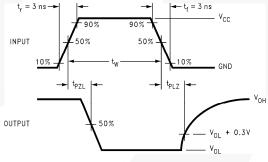
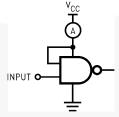


Figure 5. AC Waveforms



#### Note:

4. Input=AC Waveform; t<sub>r</sub>=t<sub>f</sub>=1.8ns; PRR=10MHz; Duty Cycle=50%.

Figure 6. Test Circuit

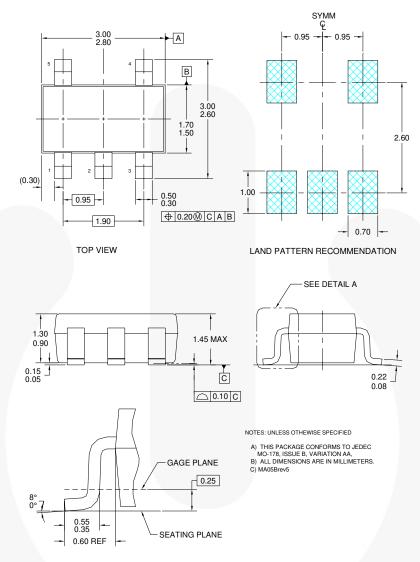


Figure 7. 5-Lead SOT23, JEDEC MO-178 1.6mm

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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
M5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

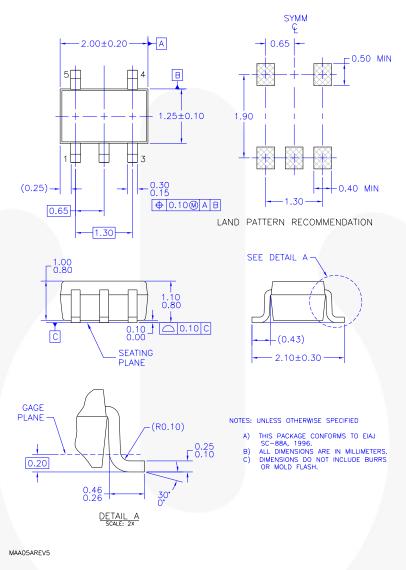


Figure 8. 5-Lead, SC70, EIAJ SC-88a, 1.25mm Wide

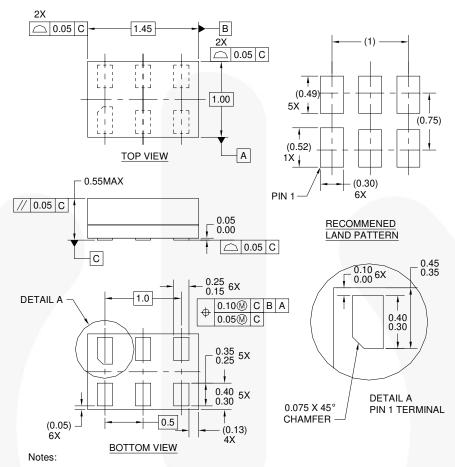
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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status	
	Leader (Start End)	125 (Typical)	Empty	Sealed	
P5X	Carrier	3000	Filled	Sealed	
	Trailer (Hub End)	75 (Typical)	Empty	Sealed	



- 1. CONFORMS TO JEDEC STANDARD M0-252 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

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Figure 9. 6-Lead, MicroPak™, 1.0mm Wide

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Package Designator	Tape Section	Cavity Number	<b>Cavity Status</b>	Cover Type Status	
	Leader (Start End)	125 (Typical)	Empty	Sealed	
L6X	Carrier	5000	Filled	Sealed	
	Trailer (Hub End)	75 (Typical)	Empty	Sealed	

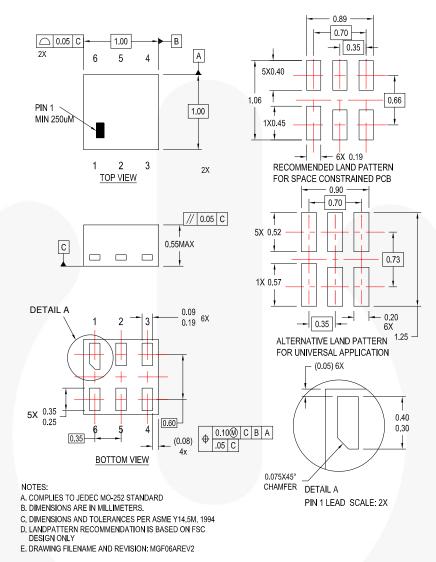


Figure 10. 6-Lead, MicroPak2, 1x1mm Body, .35mm Pitch

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Package Designator	Tape Section	be Section Cavity Number		Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
FHX	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed





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